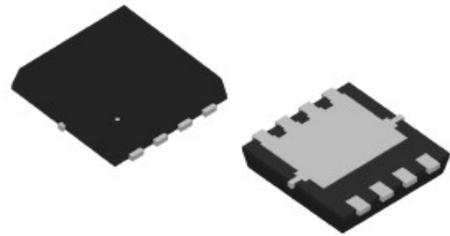


WPM3033

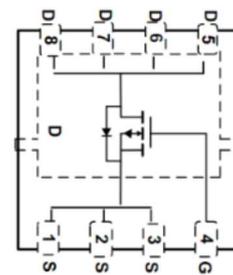
Single P-Channel, -30V, -38A, Power MOSFET

<https://www.omnivision-group.com>

V _{DS} (V)	Typical R _{DS(on)} (mΩ)
-30	5.5 @ V _{GS} =-10V
	8.5 @ V _{GS} =-4.5V



PDFN3X3-8L



Description

The WPM3033 is P-Channel enhancement MOS Field Effect Transistor. Uses advanced trench technology and design to provide excellent R_{DS(ON)} with low gate charge. This device is suitable for use in DC-DC conversion, power switch and charging circuit. Standard Product WPM3033 is Pb-free.

Pin configuration (Top view)



3033 = Device Code
PS = Special Code
Y = Year
W = Week(A~z)

Marking

Features

- Trench Technology
- Super high density cell design
- Excellent ON resistance
- Extremely Low Threshold Voltage
- Small package PDFN3X3-8L

Applications

- DC/DC converters
- Power supply converters circuit
- Load/Power Switching for portable device

Order information

Device	Package	Shipping
WPM3033-8/TR	PDFN3X3-8L	3000/Tape&Reel

Absolute Maximum ratings

Parameter	Symbol	Maximum	Unit	
Drain-Source Voltage	V_{DS}	-30	V	
Gate-Source Voltage	V_{GS}	± 25		
Continuous Drain Current ^d	I_D	$T_C=25^\circ\text{C}$	-38	A
		$T_C=100^\circ\text{C}$	-38	A
Pulsed Drain Current ^c	I_{DM}	-110	A	
Continuous Drain Current	I_{DSM}	$T_A=25^\circ\text{C}$	-21	A
		$T_A=70^\circ\text{C}$	-17	
Avalanche Current	I_{AS}	-40	A	
Avalanche Energy	$L=0.1\text{mH}, I_D=-40\text{A}, R_G=25\Omega$	E_{AS}	80	mJ
Power Dissipation ^b	P_D	$T_C=25^\circ\text{C}$	43.1	W
		$T_C=100^\circ\text{C}$	17.2	
Power Dissipation ^a	P_{DSM}	$T_A=25^\circ\text{C}$	4.6	W
		$T_A=70^\circ\text{C}$	3.0	
Operating Junction Temperature	T_J	-55 to 150	$^\circ\text{C}$	
Storage Temperature Range	T_{STG}	-55 to 150	$^\circ\text{C}$	

100% UIS tested in condition of $V_D=-20\text{V}$, $L=0.1\text{mH}$, $V_G=-10\text{V}$, $I_D=-40\text{A}$, Rated $V_{DS}=-30\text{V P-CH}$.

Thermal resistance ratings

Single Operation					
Parameter		Symbol	Typical	Maximum	Unit
Junction-to-Ambient Thermal Resistance ^a	$t \leq 10\text{ s}$	$R_{\theta JA}$	21	27	$^\circ\text{C/W}$
	Steady State		48	60	
Junction-to-Case Thermal Resistance	Steady State	$R_{\theta JC}$	2.3	2.9	

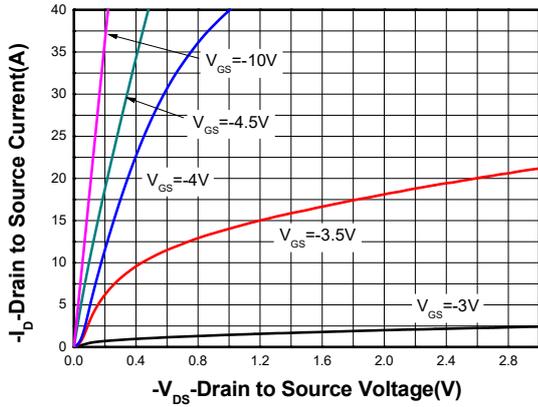
Note:

- a The value of $R_{\theta JA}$ is measured with the device mounted on 1-inch² (6.45cm²) with 2oz. (0.071mm thick) Copper pad on a 1.5*1.5 inch², 0.06-inch thick FR4 PCB, in a still air environment with $T_A=25^\circ\text{C}$. The power dissipation P_{DSM} is based on $R_{\theta JA}$ $t \leq 10\text{s}$ value and the $T_{J(MAX)}=150^\circ\text{C}$. The value in any given application is determined by the user's specific board design.
- b The power dissipation P_D is based on $T_{J(MAX)}=150^\circ\text{C}$, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.
- c Repetitive rating, $\sim 10\mu\text{s}$ pulse width, duty cycle $\sim 1\%$, keep initial $T_J=25^\circ\text{C}$, the maximum allowed junction temperature of 150°C .
- d The maximum current rating by source bonding technology.
- e The static characteristics are obtained using $\sim 380\mu\text{s}$ pulses, duty cycle $\sim 1\%$.

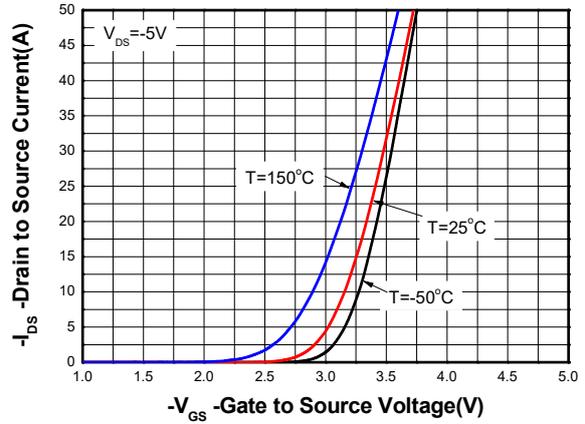
Electronics Characteristics (Ta=25°C, unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
Drain-to-Source Breakdown Voltage	BV _{DSS}	V _{GS} = 0 V, I _D = -250uA	-30			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -24V, V _{GS} = 0V			-1	uA
Gate-to-source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = ±25V			±100	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	V _{GS(TH)}	V _{GS} =V _{DS} , I _D = -250uA	-1.0	-1.7	-2.2	V
Drain-to-source On-resistance	R _{DS(on)}	V _{GS} = -10V, I _D = -20A		5.7	7.5	mΩ
		V _{GS} = -4.5V, I _D = -16A		8.6	12.5	
Forward Transconductance	g _{FS}	V _{DS} = -5V, I _D = -10A		23		S
CHARGES, CAPACITANCES AND GATE RESISTANCE						
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1.0MHz, V _{DS} = -15 V		2686		pF
Output Capacitance	C _{OSS}			476		
Reverse Transfer Capacitance	C _{RSS}			417		
Gate resistance	R _g	F=1MHz		12.5		Ω
Total Gate Charge	Q _{G(TOT)}	V _{GS} = -10V, V _{DS} = -15V, I _D = -20 A		58.2		nC
Threshold Gate Charge	Q _{G(TH)}			4.8		
Gate-to-Source Charge	Q _{GS}			11.1		
Gate-to-Drain Charge	Q _{GD}			11.5		
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	t _{d(ON)}	V _{GS} = -10V, V _{DS} = -15 V, I _D = -20A, R _G = 3Ω		22.5		ns
Rise Time	t _r			20.5		
Turn-Off Delay Time	t _{d(OFF)}			126.5		
Fall Time	t _f			67.5		
BODY DIODE CHARACTERISTICS						
Forward Voltage	V _{SD}	V _{GS} = 0 V, I _S = -1A		-0.7	-1.2	V
Reverse Recovery Time	t _{rr}	I _F = -16A,		48		ns
Reverse Recovery Charge	Q _{rr}	di/dt = 100A/us		28		nC

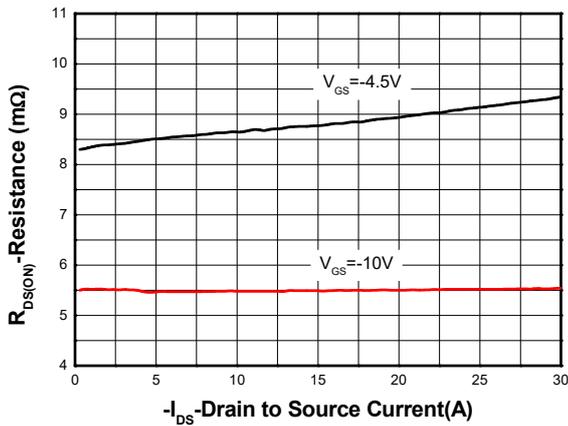
Typical Characteristics (Ta=25°C, unless otherwise noted)



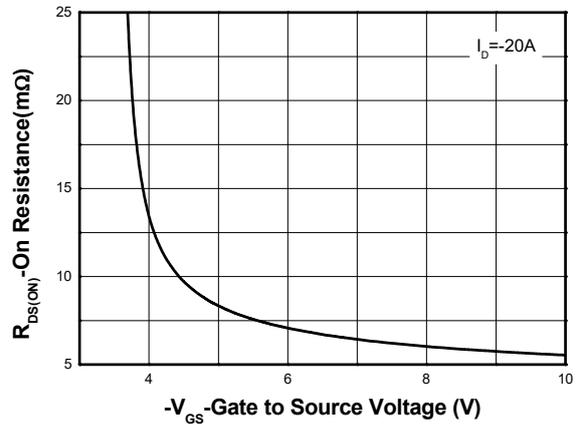
Output Characteristics ^e



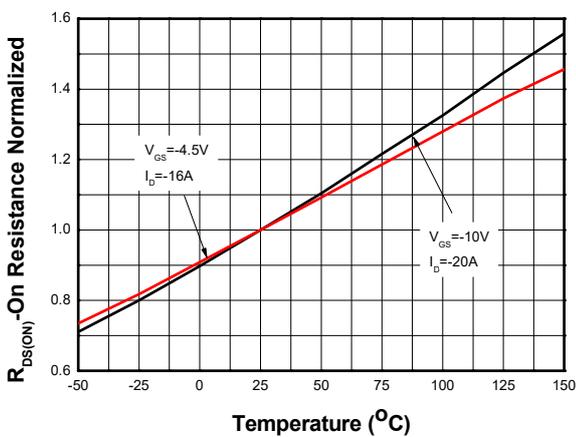
Transfer Characteristics ^e



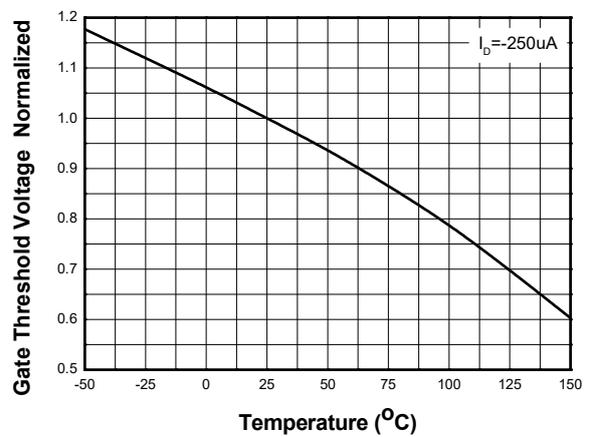
On-Resistance vs. Drain Current ^e



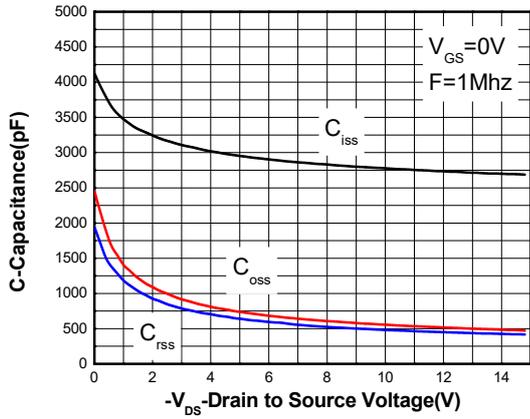
On-Resistance vs. Gate-to-Source Voltage ^e



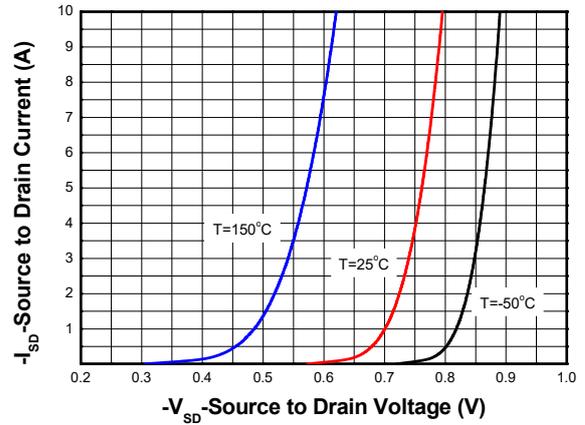
On-Resistance vs. Junction Temperature ^e



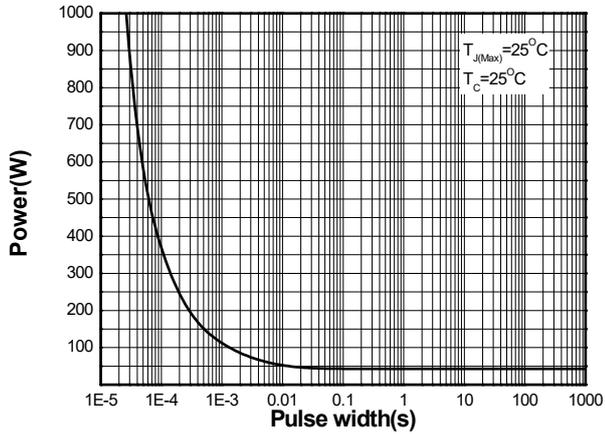
Threshold Voltage vs. Temperature



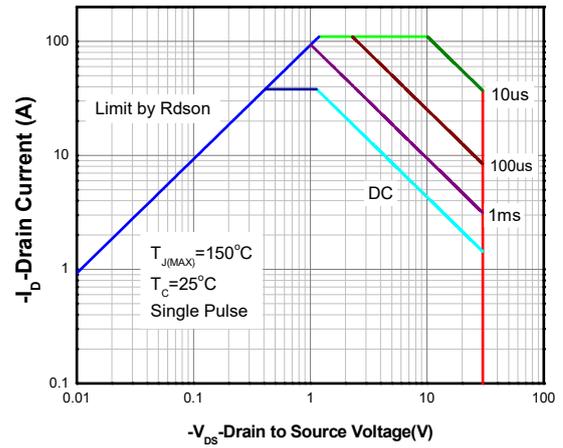
Capacitance



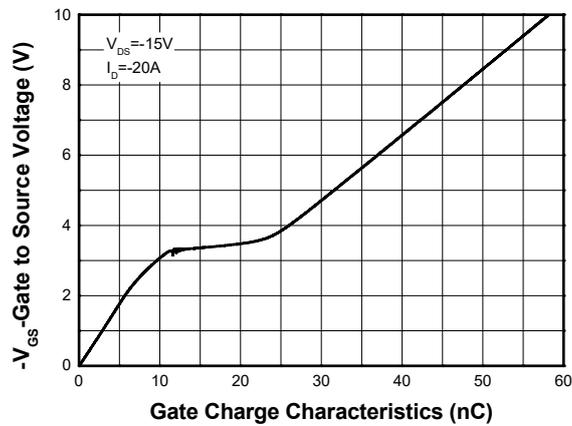
Body Diode Forward Voltage^e



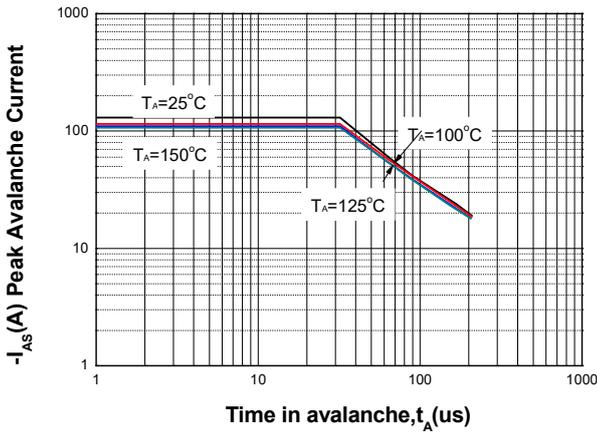
Single Pulse power



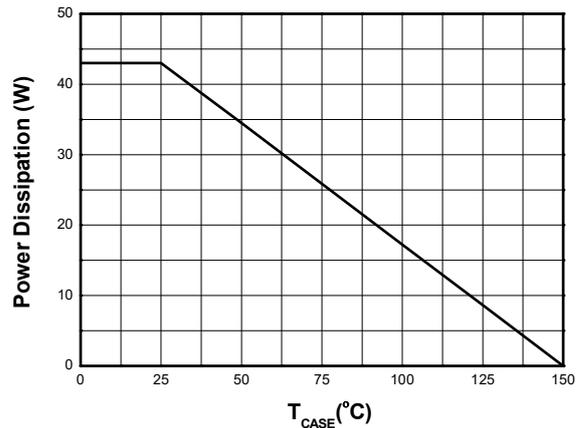
Safe Operating Power



Gate Charge Characteristics

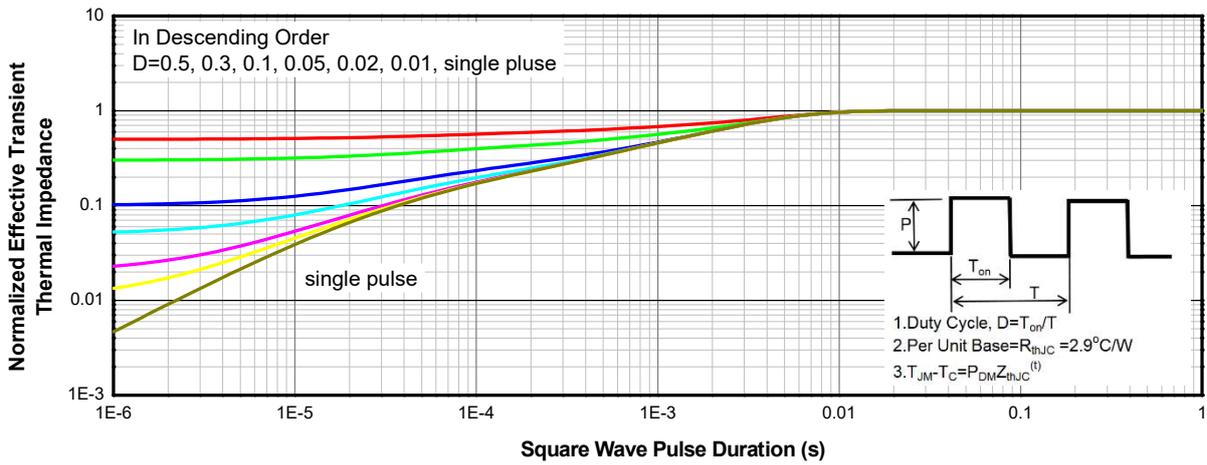


Single Pulse Avalanche capability

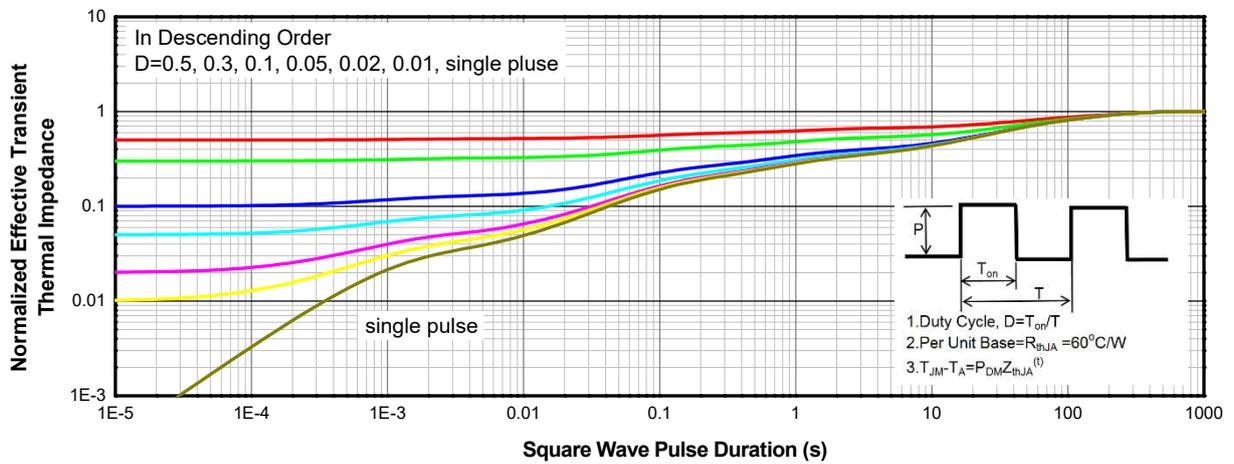


Power De-rating

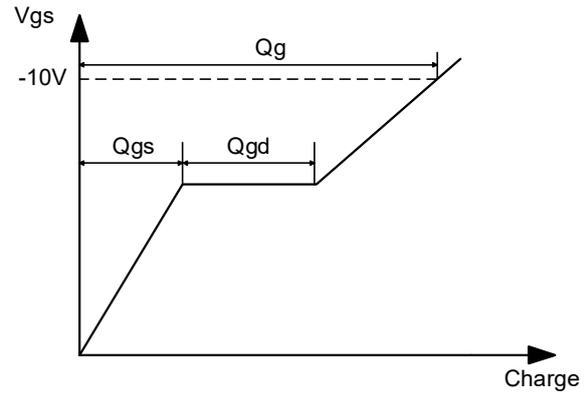
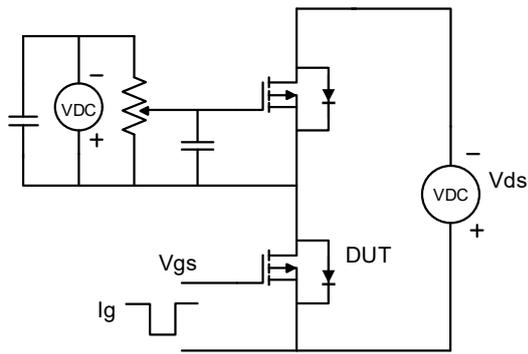
Transient Thermal Response (Junction-to-Case)



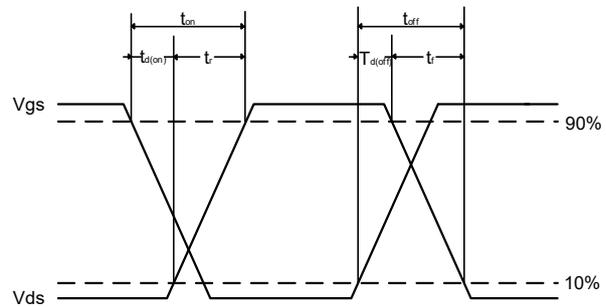
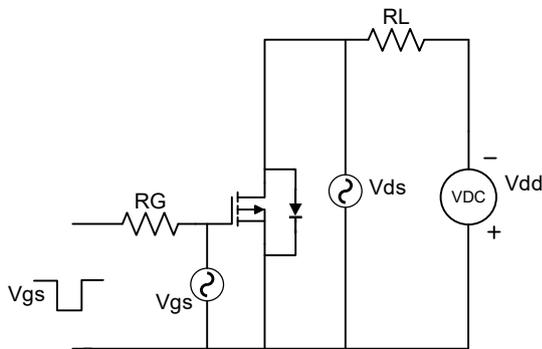
Transient Thermal Response (Junction-to-Ambient)



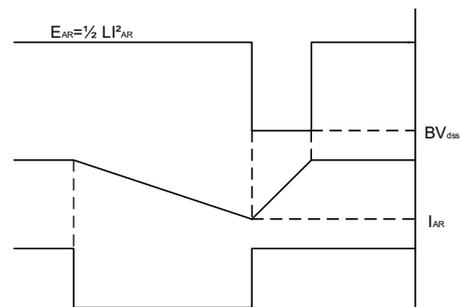
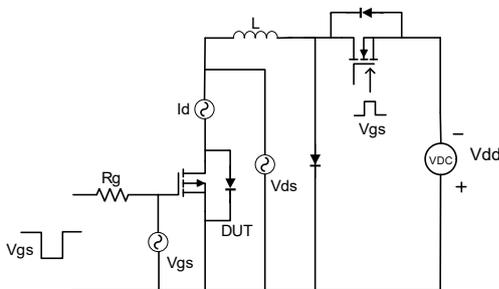
Gate Charge Test Circuit & Waveform



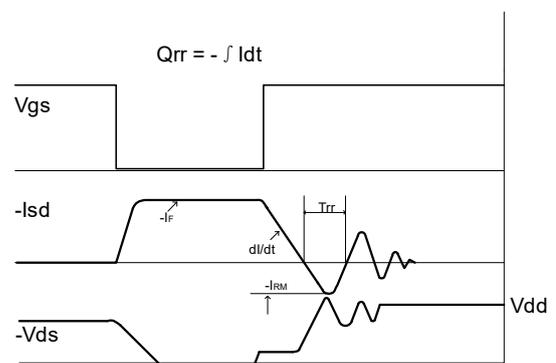
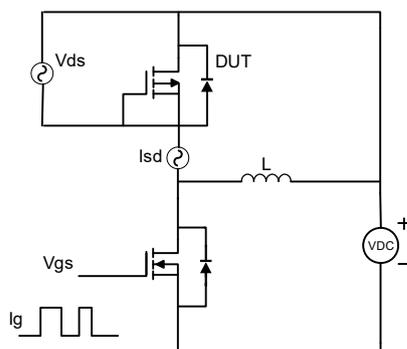
Resistive Switching Test Circuit & Waveform



Unclamped Inductive Switching(UIS) Test Circuit & Waveform

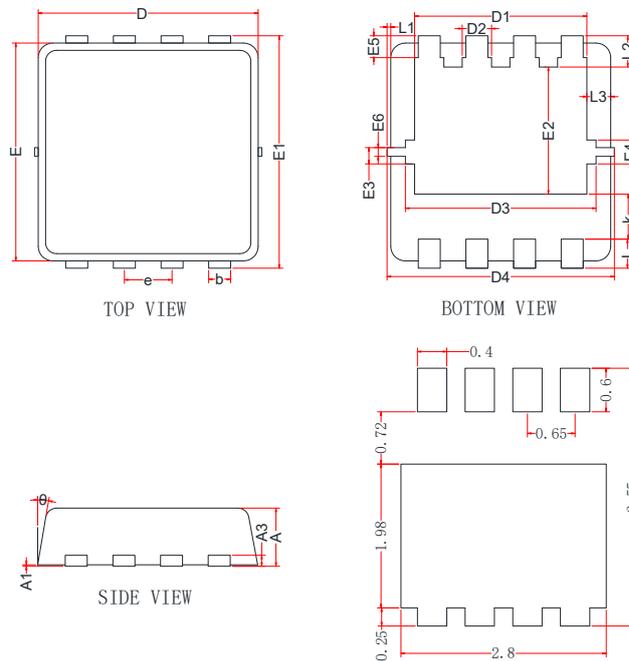


Diode Recovery Test Circuit & Waveform

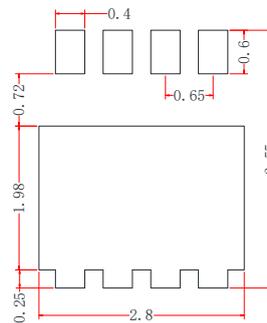


PACKAGE OUTLINE DIMENSIONS

PDFN3x3-8L



RECOMMENDED LAND PATTERN (Unit:mm)



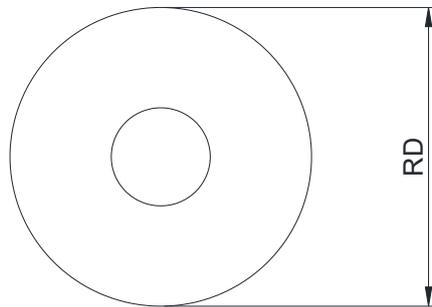
Symbol	Dimensions in Millimeters		
	Min.	Typ.	Max.
A	0.70	0.80	0.90
A1	0.00	0.02	0.05
A3	0.10	0.15	0.25
b	0.24	0.30	0.35
D	2.90	3.00	3.10
D1	2.25	2.35	2.45
D2	0.30	0.40	0.50
D3	2.50	2.60	2.70
D4	3.00	3.10	3.20
E	2.90	3.00	3.10
E1	3.10	3.20	3.30
E2	1.65	1.75	1.85
E3	0.48	0.58	0.68
E4	0.23	0.33	0.43
E5	0.20	0.30	0.40
E6	0.07	0.12	0.18
e	0.60	0.65	0.70
K	0.52	0.62	0.72



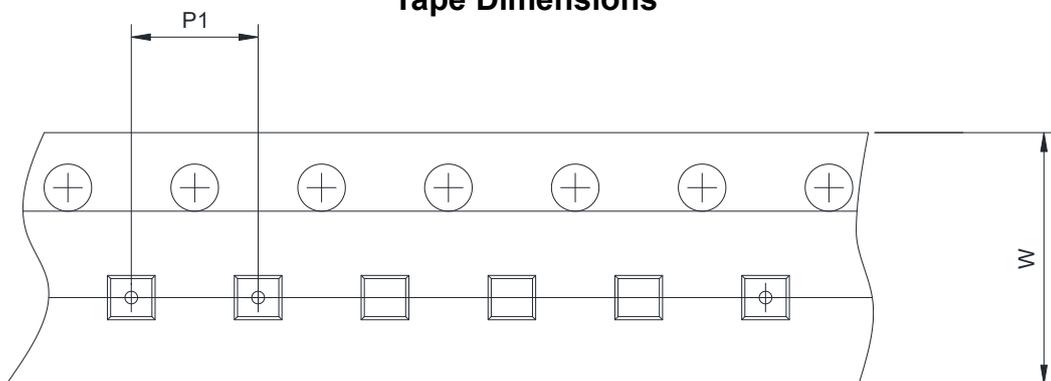
L	0.30	0.40	0.50
L1	0.00	0.05	0.10
L2	0.33	0.43	0.53
L3	0.27	0.37	0.48
θ	0°	10°	12°

TAPE AND REEL INFORMATION

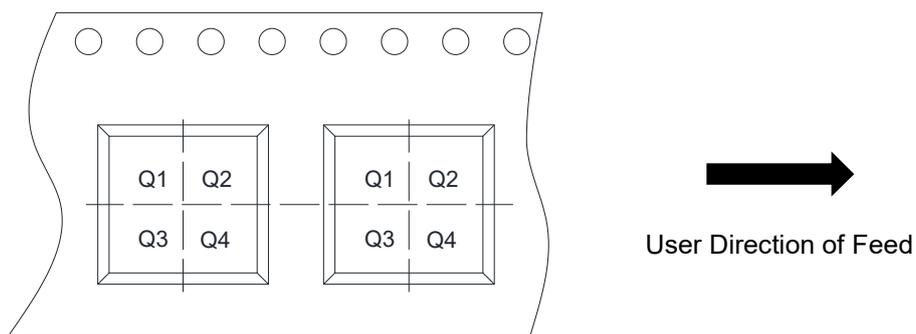
Reel Dimensions



Tape Dimensions



Quadrant Assignments For PIN1 Orientation In Tape



RD	Reel Dimension	<input type="checkbox"/> 7inch	<input checked="" type="checkbox"/> 13inch
W	Overall width of the carrier tape	<input type="checkbox"/> 8mm	<input checked="" type="checkbox"/> 12mm <input type="checkbox"/> 16mm
P1	Pitch between successive cavity centers	<input type="checkbox"/> 2mm	<input type="checkbox"/> 4mm <input checked="" type="checkbox"/> 8mm
Pin1	Pin1 Quadrant	<input checked="" type="checkbox"/> Q1	<input type="checkbox"/> Q2 <input type="checkbox"/> Q3 <input type="checkbox"/> Q4

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[DMN2990UFB-7B](#) [SSM3K35CT,L3F](#) [IPLK60R1K0PFD7ATMA1](#) [2N7002W-G](#) [MCAC30N06Y-TP](#) [IPWS65R035CFD7AXKSA1](#)
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[PJMF600N65E1_T0_00201](#) [PJMF900N65E1_T0_00201](#) [PJMF900N60E1_T0_00201](#)